

Title (en)  
CONNECTION ARRANGEMENT, CONNECTION TERMINAL AND ELECTRONIC DEVICE

Title (de)  
ANSCHLUSSANORDNUNG, ANSCHLUSSKLEMME SOWIE ELEKTRONISCHES GERÄT

Title (fr)  
DISPOSITIF DE CONNEXION, BORNE DE CONNEXION ET DISPOSITIF ÉLECTRONIQUE

Publication  
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Application  
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Abstract (en)  
[origin: WO2021028263A1] The invention relates to a connection arrangement (100) for connecting an electrical conductor, comprising a busbar (13), a clamping spring (14) by means of which the conductor to be connected is clamped against the busbar (13) in a clamping position of the clamping spring (14), and an operating element (18) by means of which the clamping spring (14) can be moved from the clamping position to an open position, wherein a holding element (27) is provided which engages with the operating element (18) in the open position in order to hold the operating element (18) in position, wherein the holding element (27) has a pressure surface (28), wherein, for the purpose of moving the clamping spring (14) from the open position to the clamping position, the pressure surface (28) can be operated by the conductor to be connected and the holding element (27) can be disengaged from the operating element (18) by the operation of the pressure surface (28).

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